

# black

semiconductor

Graphene for integrated photonics  
Cedric Huyghebaert, CTO

EPIC meeting on CMOS compatible Integrated Photonics  
Leuven Belgium : 7-8 septmeber 2022

# Black semiconductor

- Black Semiconductor is developing breakthrough technologies to traditional electronic systems with photonics.
- Black Semiconductor is a start-up issues out of RWTH & AMO in Aachen
- Founded in 2019
- Black semiconductor closed his seed round of 6,2m euros at the end of last year in support for the development of bringing optical circuits to any electronic chip.
- Operations started in Februari 2022
- Black Semiconductor is a European company developing this technology with the help of our great investors and growing tech team.

## Advisors:

Andreas Umbach

*Chairman of the Board*

Retired CTO & VP at Finisar

Bill Leszinske

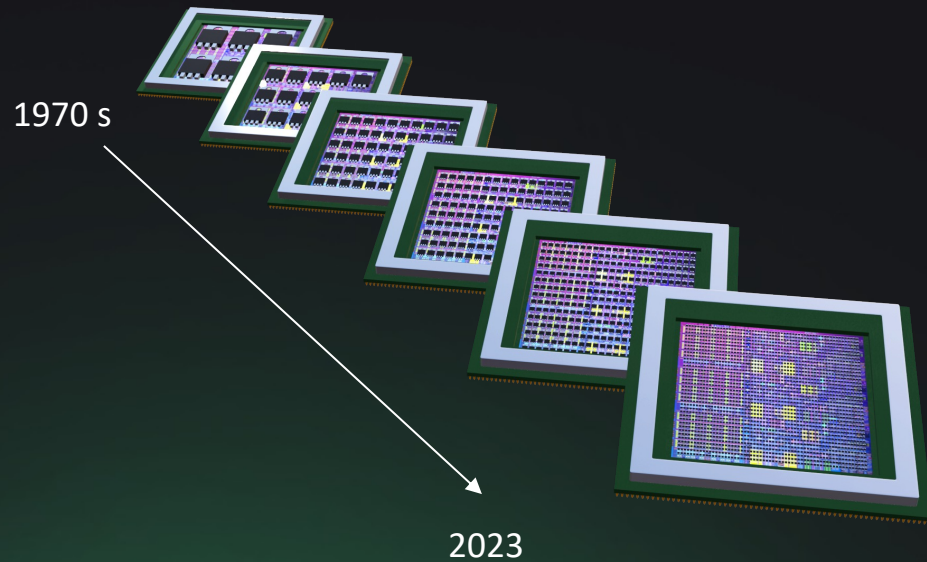
*Advisor and member of the Board*

Retired VP of storage at Intel

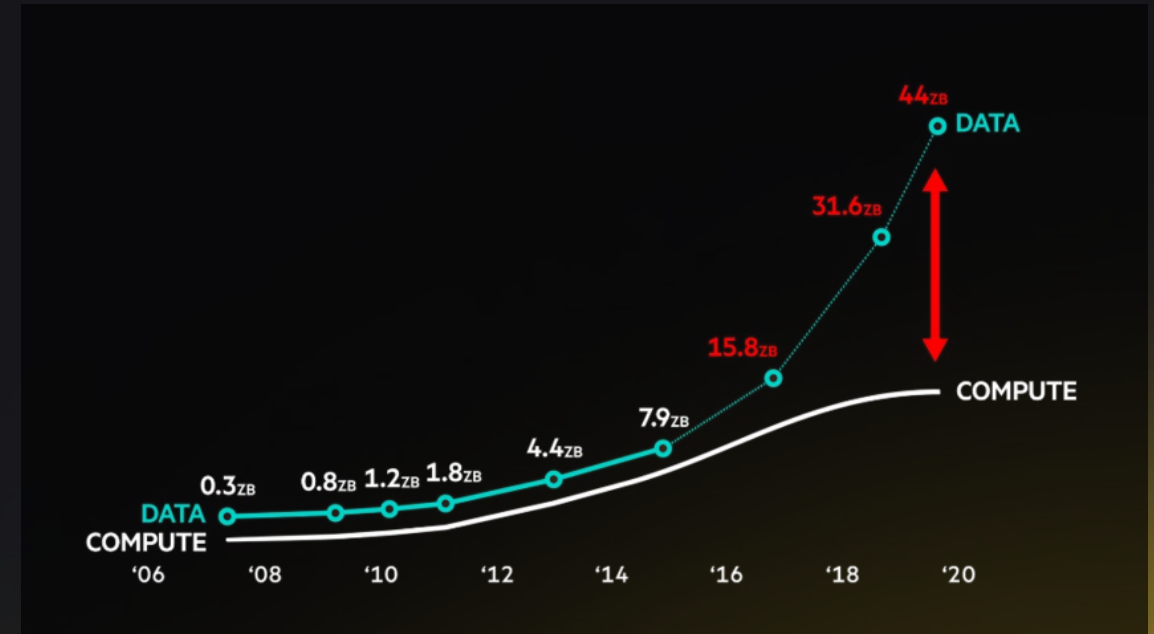
# The Problem

Multi-dimensional **hard physical limits**. **Very large markets** depend on performance boosts.

**Current tech will reach his limits**. Amount of data explodes.



DOWN scaling limits are visible!  
How to continue increasing performance?



Data curve from IDC/EMC Digital Universe reports 2008-2017, Compute curve HPE analysis, Graphic: World Economic Forum <https://www.weforum.org/agenda/2018/09/end-of-an-era-what-computing-will-look-like-after-moores-law/>

# Photonic data interfaces are fastest

## Highest possible data rates

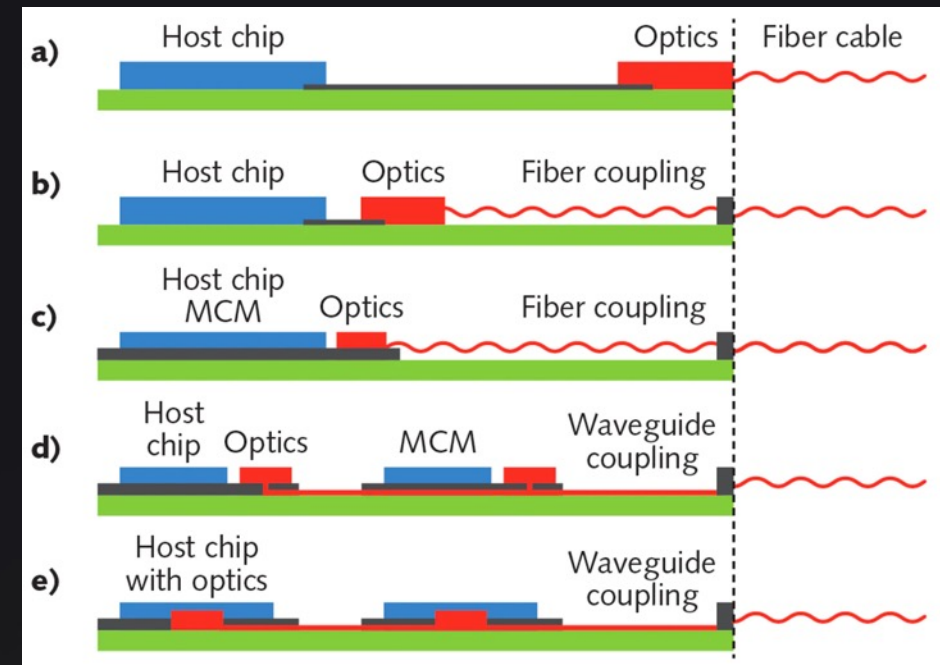
Electronic interconnects are too slow

photonic processing runs at maximum possible speed

No clock, novel architectures

## Overcome existing limits

Tb/s chip to chip communication ultimately unleash AI applications



Laser Focus World Sep 13 2019

# Solution: Photonic circuits on any electronics

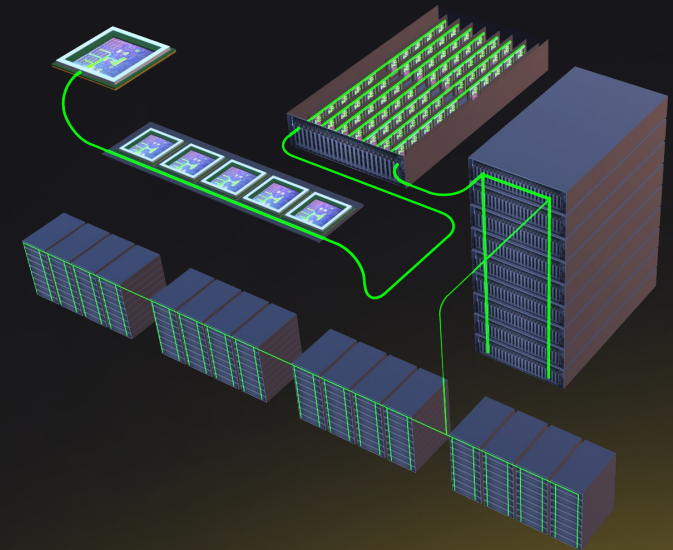
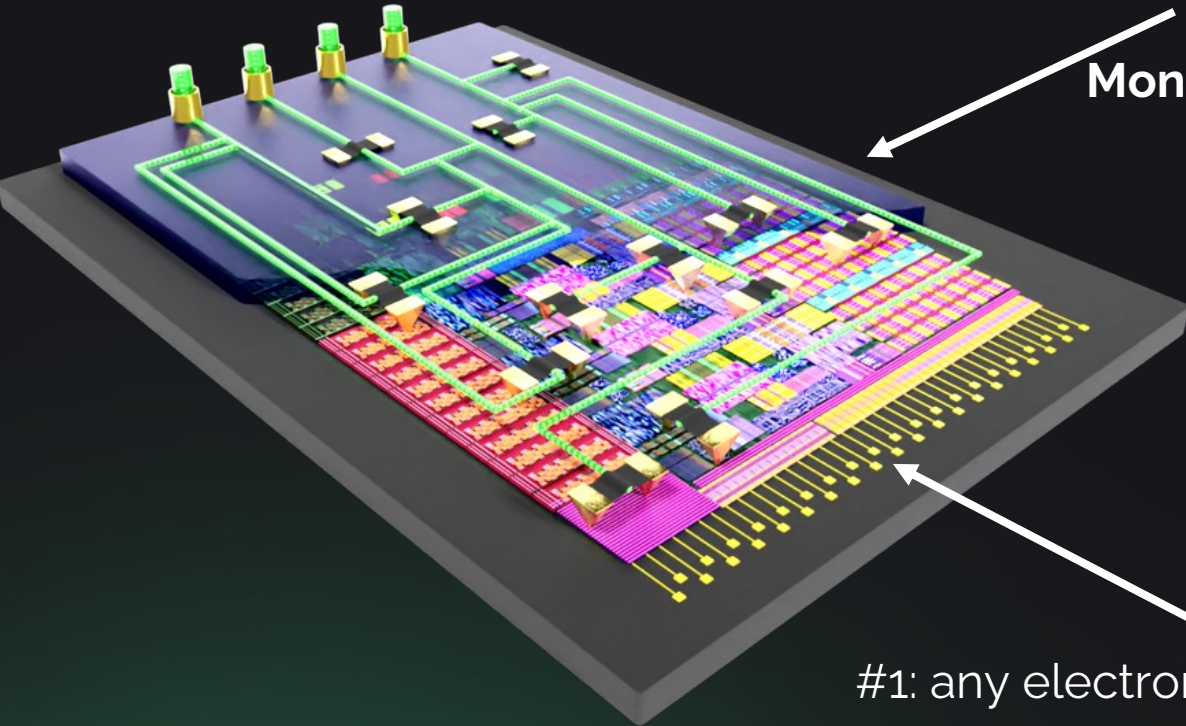
#2: photonic platform,

**Monolithic Fabrication**

#1: any electronic circuit,

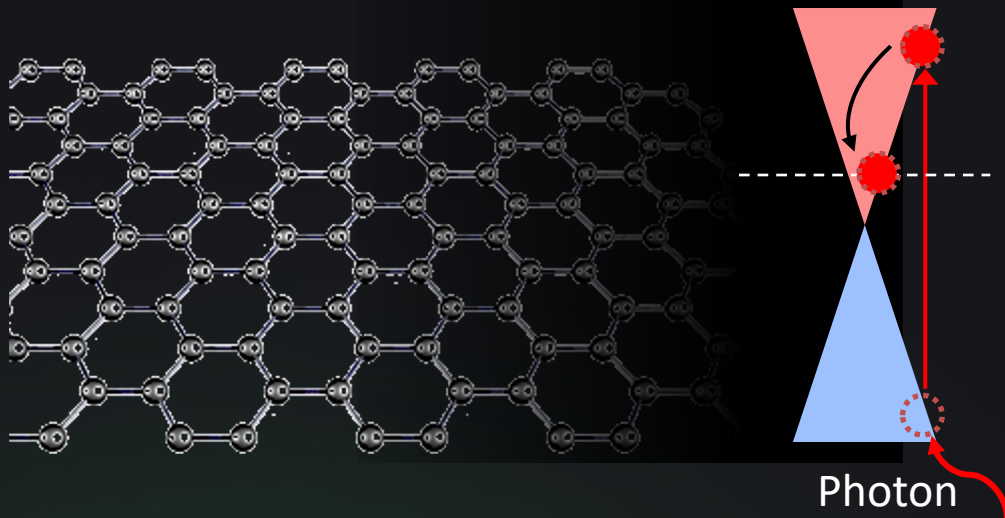
**Free choice of technology**

**Boost # transistors  
through Chip fabrics**



# How to make active photonics on top of CMOS?

Material



- Fast carrier dynamics: ultrafast devices
- Linear band structure: broadband devices
- Low density of states: efficient devices

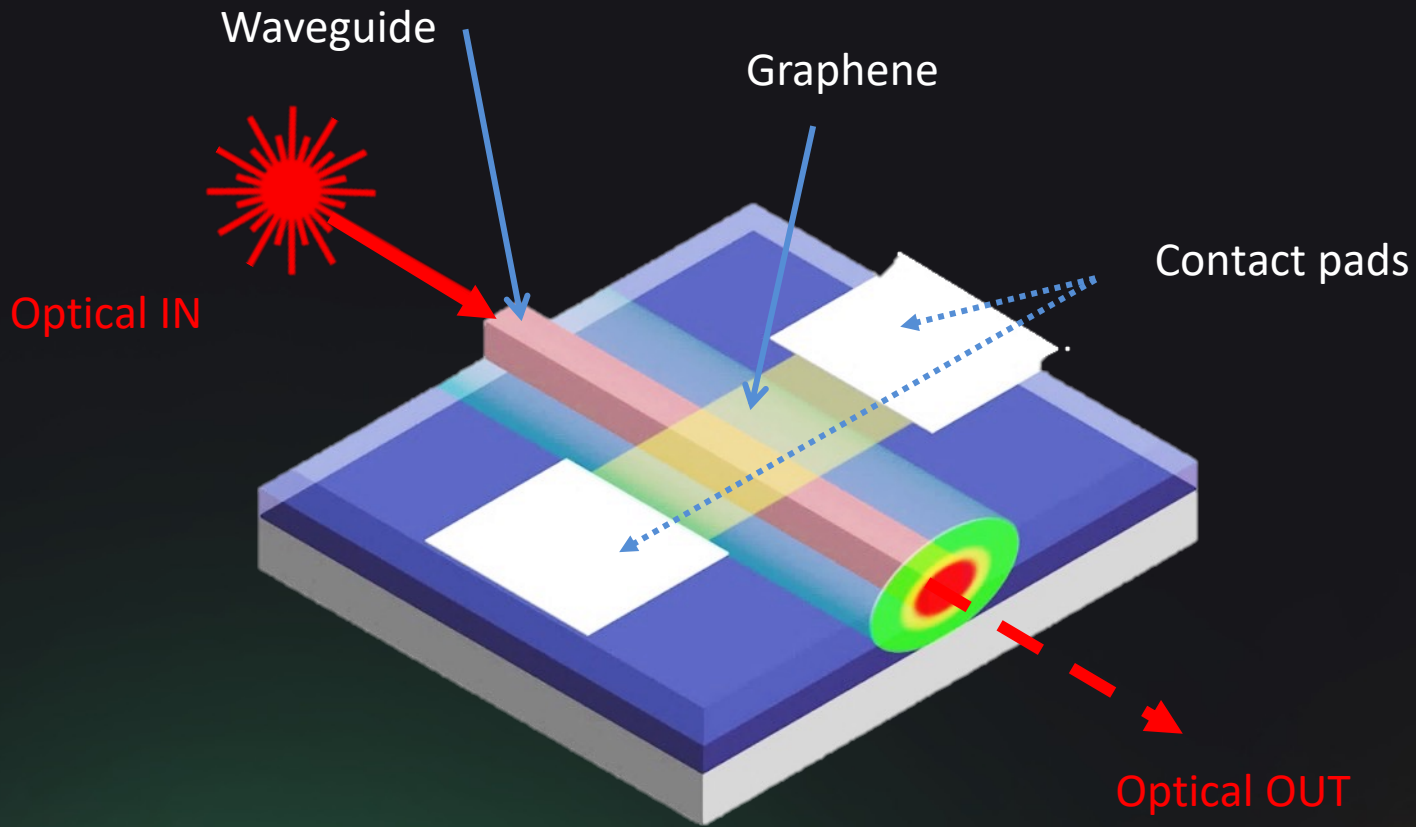
Fabrication and integration



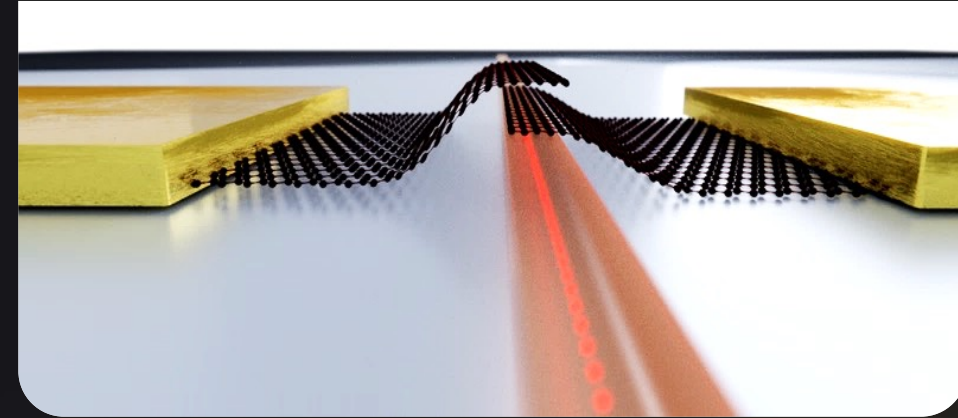
- Fabrication on large scale
- BEOL integration

► Ultra fast, efficient and broadband photonic devices on wafer scale

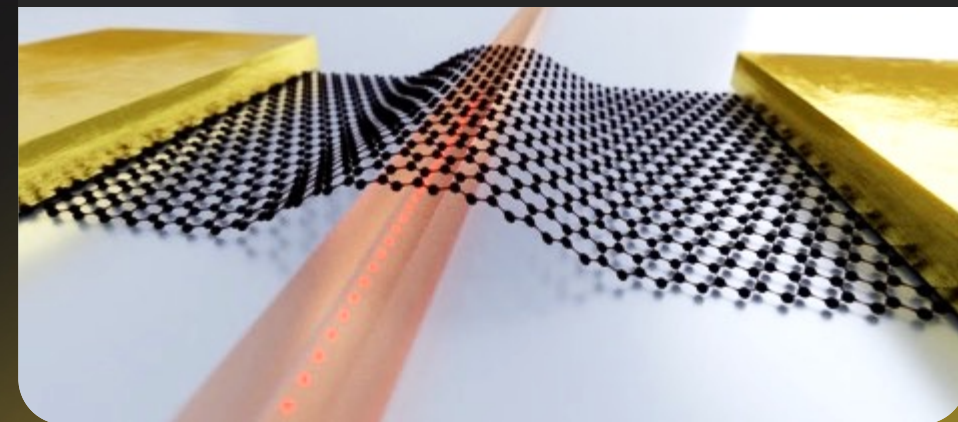
# Device schematic



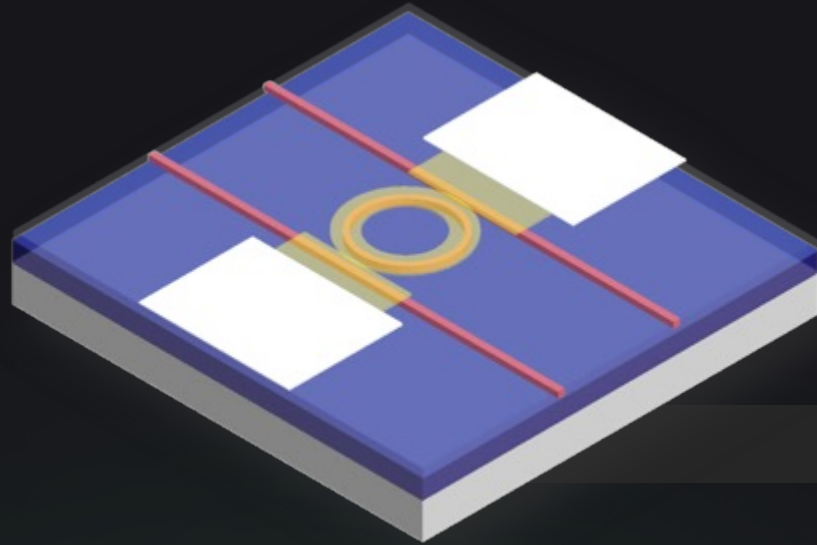
modulator = capacitor



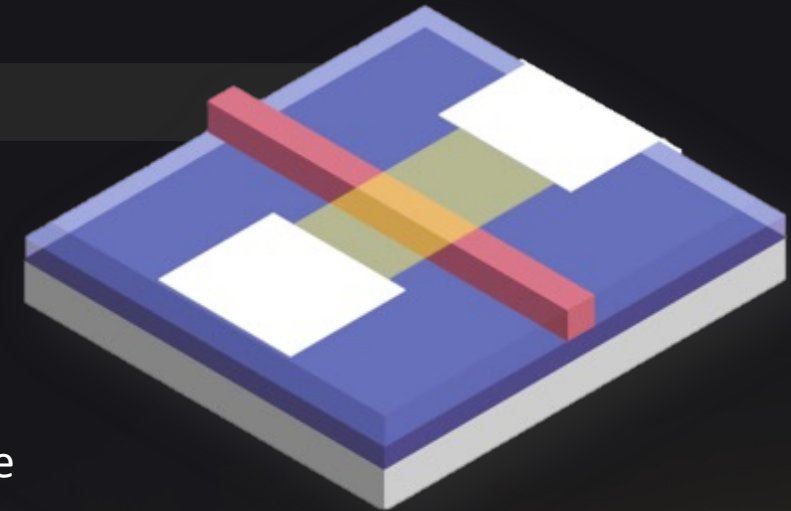
detector = resistor



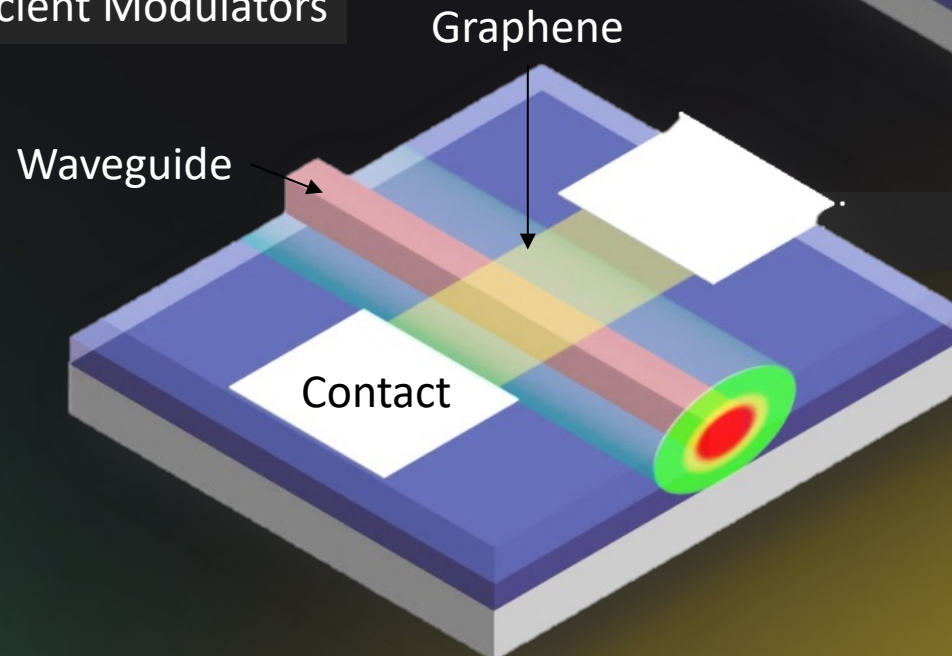
# Graphene photonics platform



Efficient Phase Shifters



Efficient Modulators

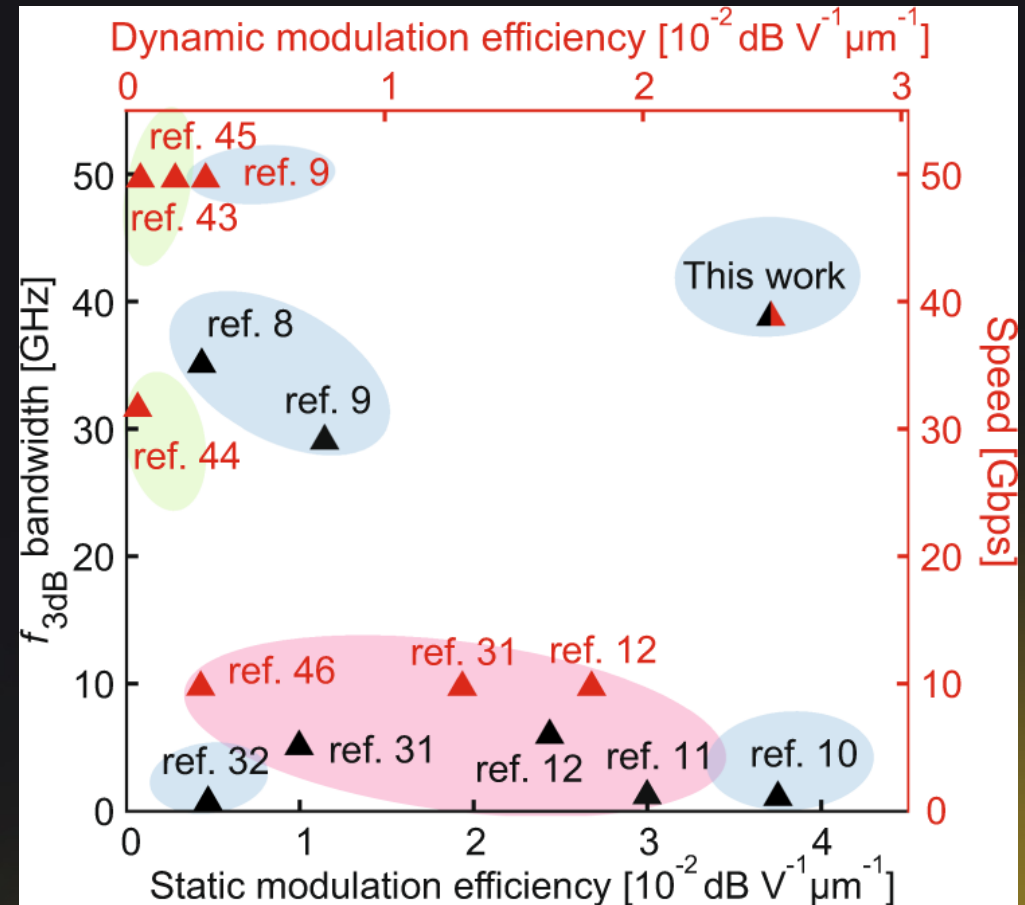
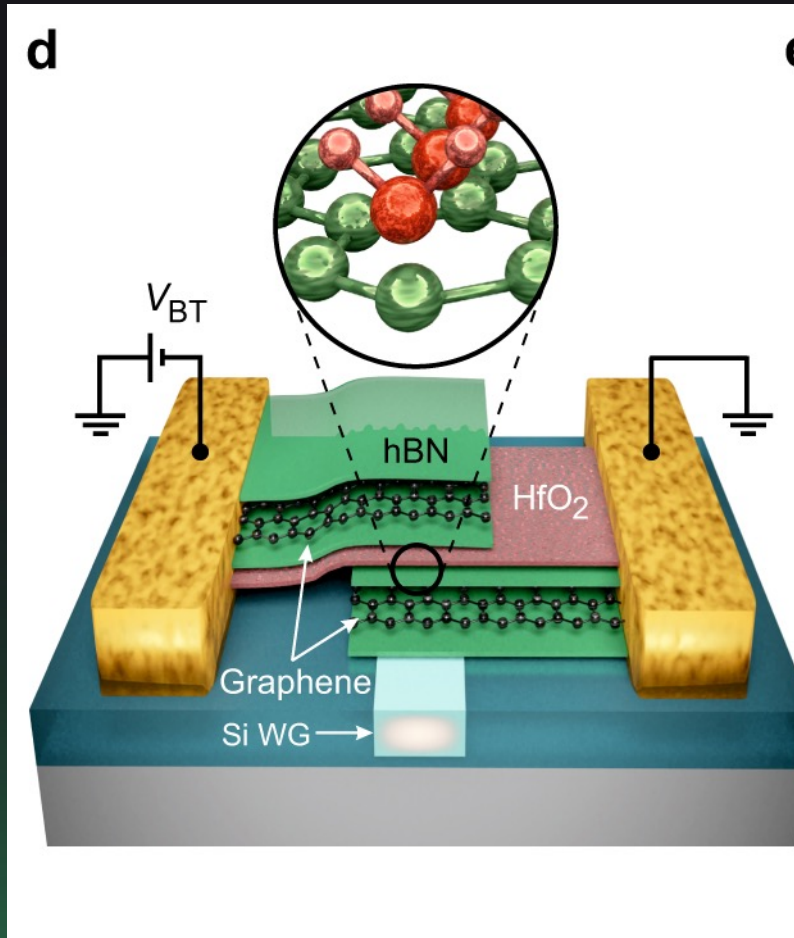


Ultrafast Photodetectors

- D. Schall et al., ACS Photonics 1 (9), 781-784 (2014).
- D. Schall, et al., J. Phys. D: Appl. Phys., (2017).
- S. Schuler et al., Nano Lett., 16 (11), 7107-7112 (2016).
- D. Schall et al., Opt. Express 24, 7871-7878 (2016).
- M. Mohsin et al., OSA paper IM4A.1 (2015).
- M. Mohsin et al Scientific Reports 5, 10967 (2015).
- M. Mohsin et al., Opt. Express 22, 15292-15297 (2014).
- Mohsin, Schall et al. Opt. Express 25, 31660-31669 (2017)
- D. Schall et al., OFC San Diego (2018).



# Graphene based modulator : fast and efficient



H. Agarwal et al. Nature Comms 1, 1070(2021)

# Why graphene photonics?

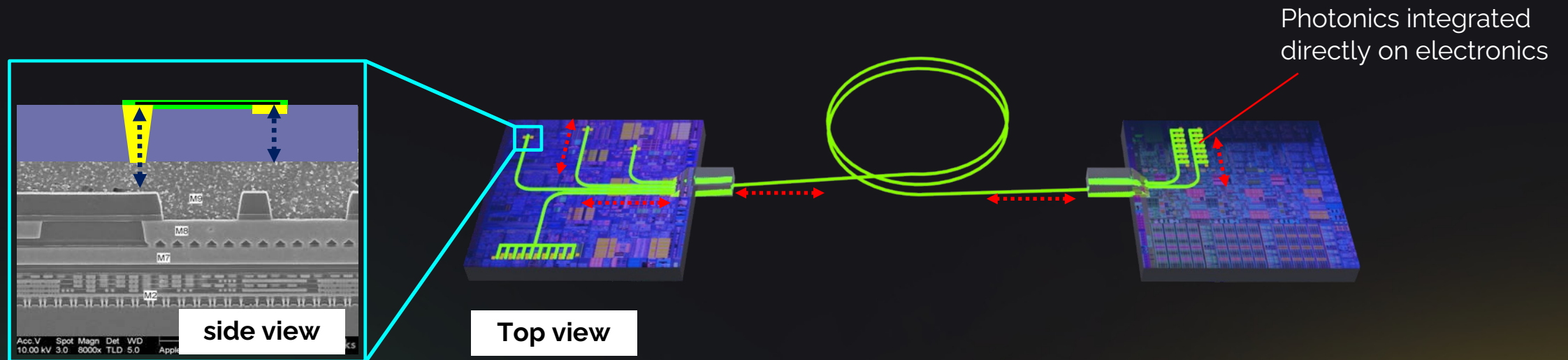
- Graphene : new material –new standards :
    - low temp budget integration
    - Amorphous waveguide compatible
    - Modulator- and detector technology in graphene
- } Compatible with BEOL
- Graphene grown on template : high temp budget needed but not on target wafer
  - Waferscale integration possible in principle
  - Flexible combination with any electronics
  - Low cost of integration possible

# Roadmap for Black semiconductor integrated Photonics:

1. Build up passive photonics platform compatible with CMOS
  - Establish and platformize the key passive photonics components on top of CMOS
  - Solve and demonstrate packaging solutions
2. development of graphene photonics platform
  - graphene based photonics from Lab to industrial relevant production
3. photonics on any electronics (product phase)
  - full integration based on stage 1 and 2 technology
  - Unlock the full power of graphene based photonics integration on CMOS

# Graphene photonic device integration on CMOS

## Integration on Electronics, maximum performance



**Integration on electronics:** on-chip and chip to chip communication

- maximum performance

# Challenges & opportunities

- Device performance strongly correlated with **graphene quality** and **dielectric environment of the graphene**
- High quality graphene not known to be able to grown directly on amorphous dielectrics => high quality requires **template** developments and **transfer developments** => non existing processes in today's semiconductor industry (developments are required)
- Trade-off between **speed** and **energy consumption** of graphene based devices
- **Reliability** of graphene based devices to be demonstrated
- Compatibility of **driver electronics** for Photonics with different CMOS nodes
- **Wafer level coupling solutions** for photonic links between chips : increase fiber densities

Thanks & Questions?

# The Team



**Dr. Cedric Huyghebaert**  
*CTO*

23 years of R&D and operational management at imec

Long time experience in 2D materials in lab as well as into 300 mm lines at imec

Management responsibility at imec



**Dr.-Ing. Daniel Schall**  
*CEO*

10+ years of graphene photonics research at leading institute AMO

Inventor & manager of the group leading to Black Semiconductor

Created the first wafer-scale graphene photonic fabrication process



**Sebastian Schall**  
*CFO*

5 years of business process automation experience

finance background

former member of the board of a telecom start-up

## Advisors:

**Andreas Umbach**

*Chairman of the Board*

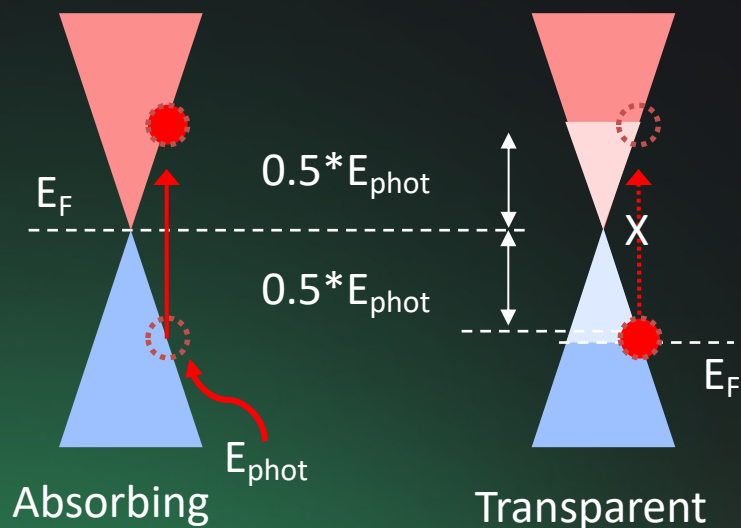
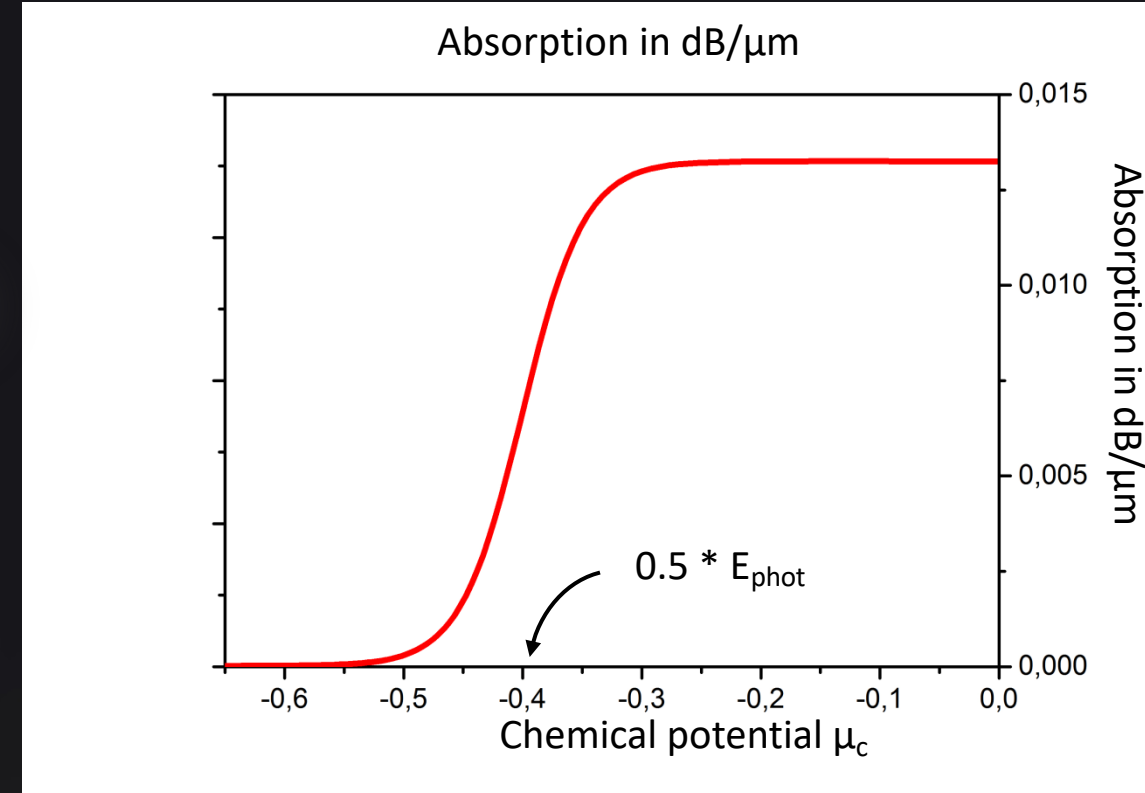
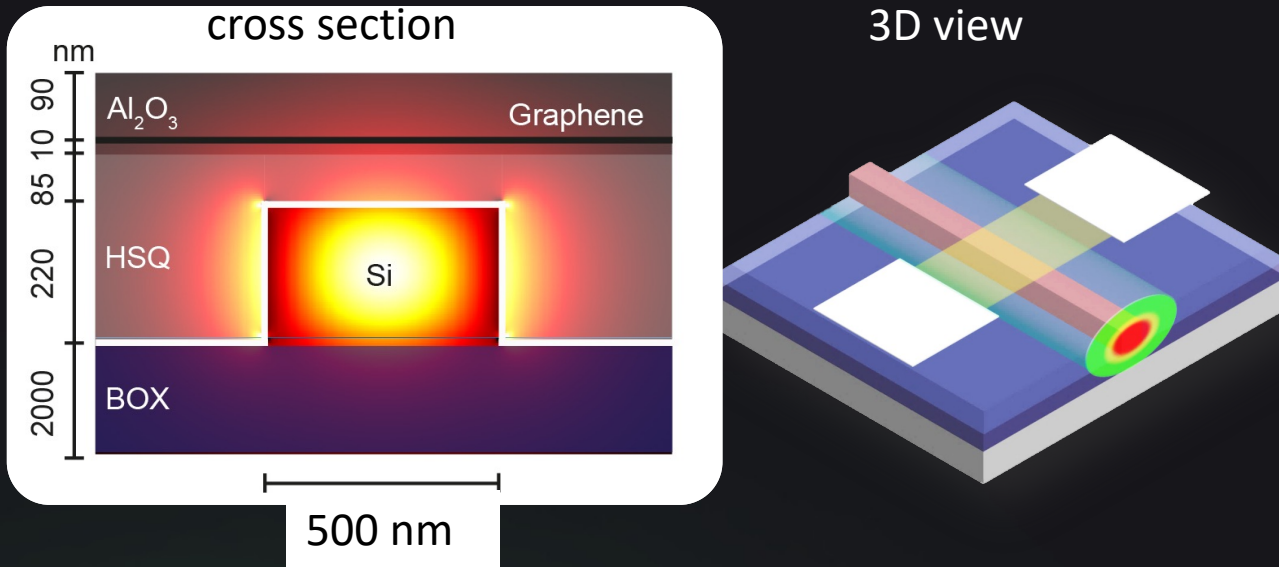
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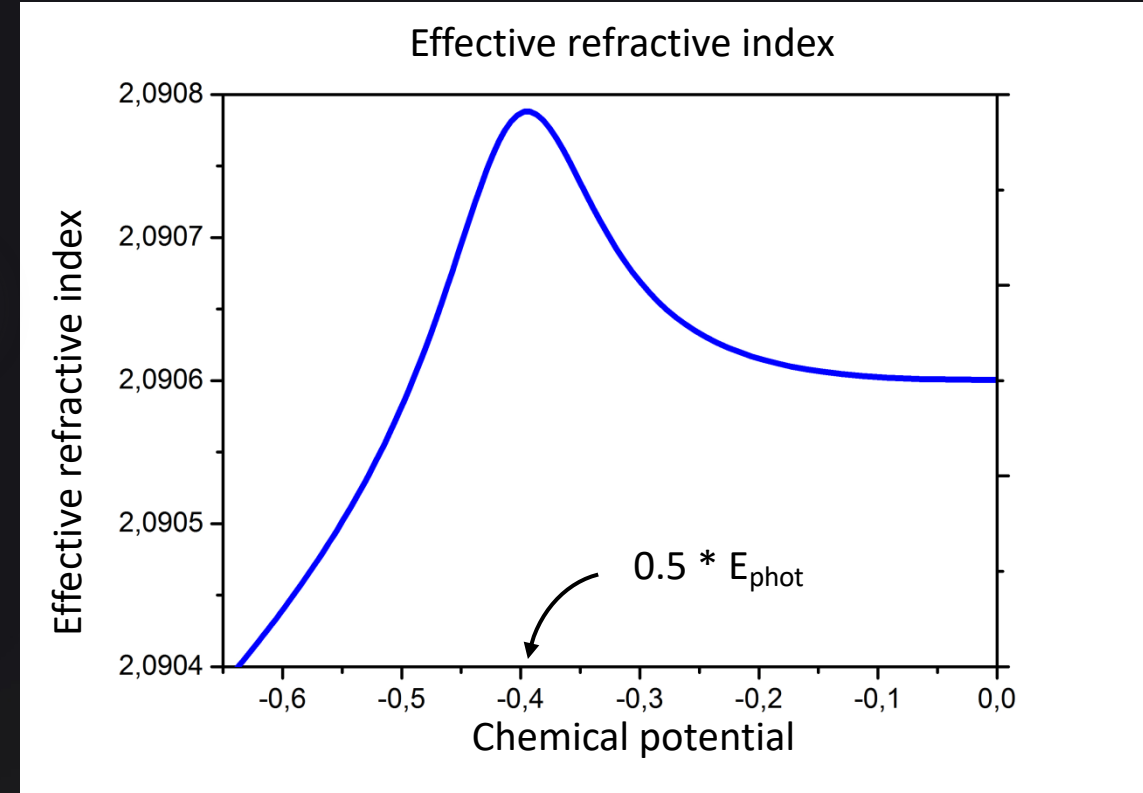
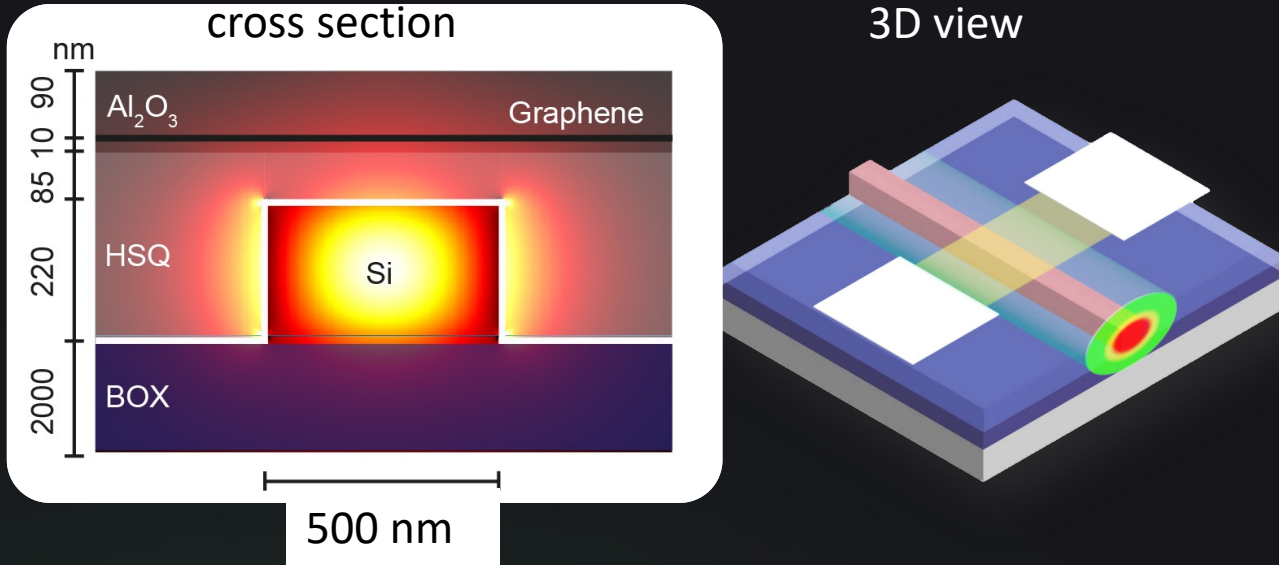
# Graphene: tunable absorption



- $\lambda = 1550 \text{ nm} \rightarrow E_{\text{phot}} = 0.8 \text{ eV}$
- For  $|\mu_c| \geq 0.5 * E_{\text{phot}}$  states are blocked  
 $\rightarrow$  graphene is transparent

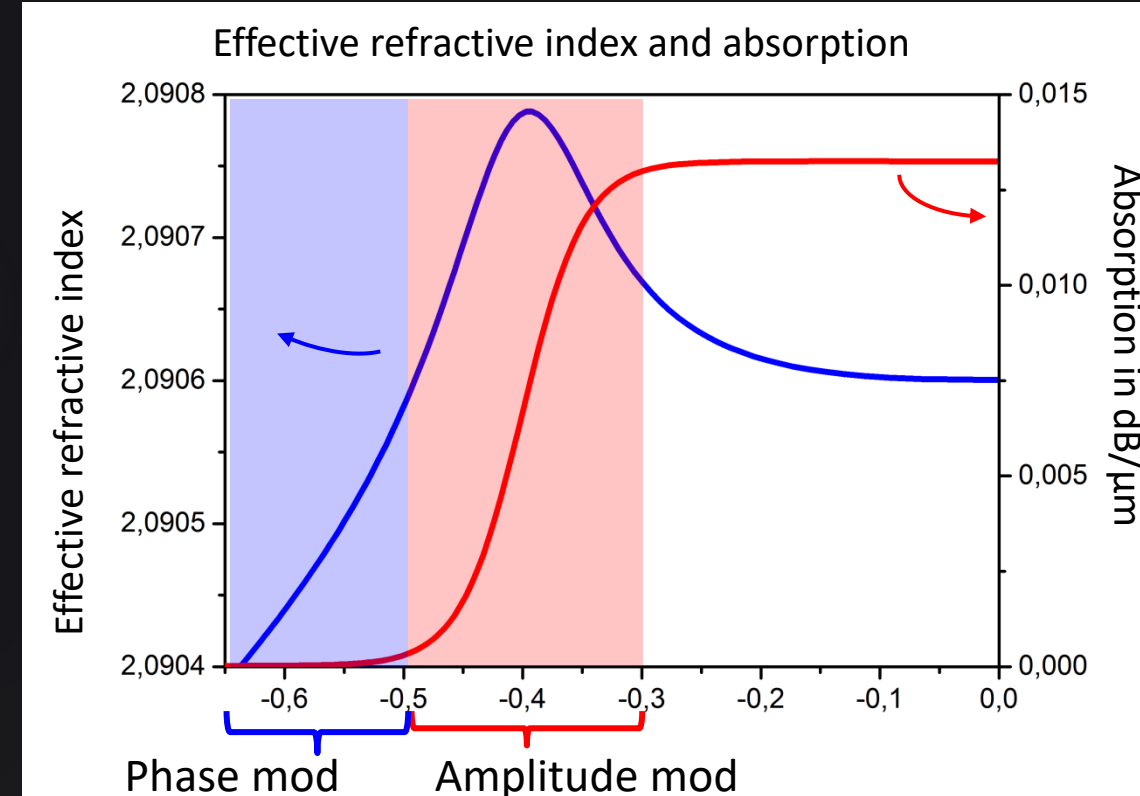
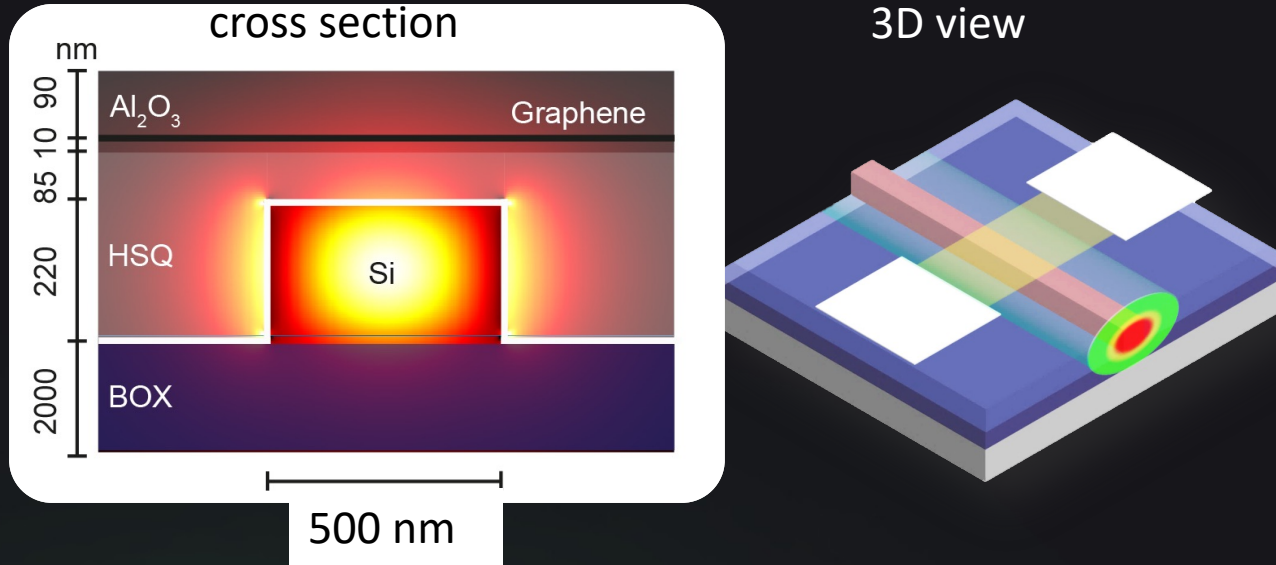


# Graphene: tunable refractive index



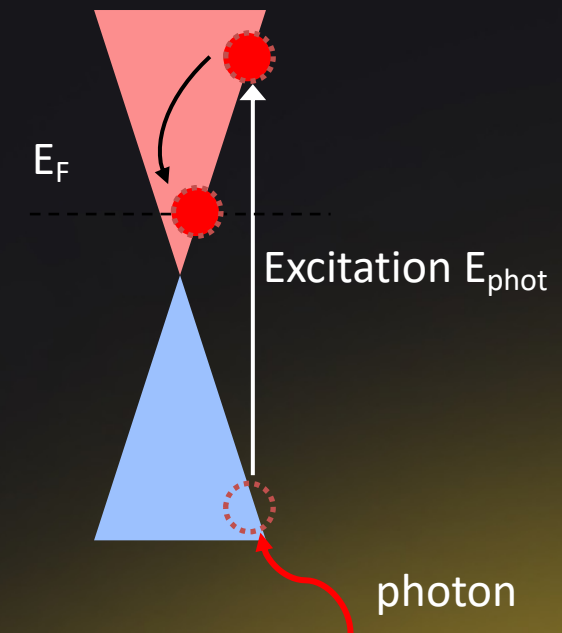
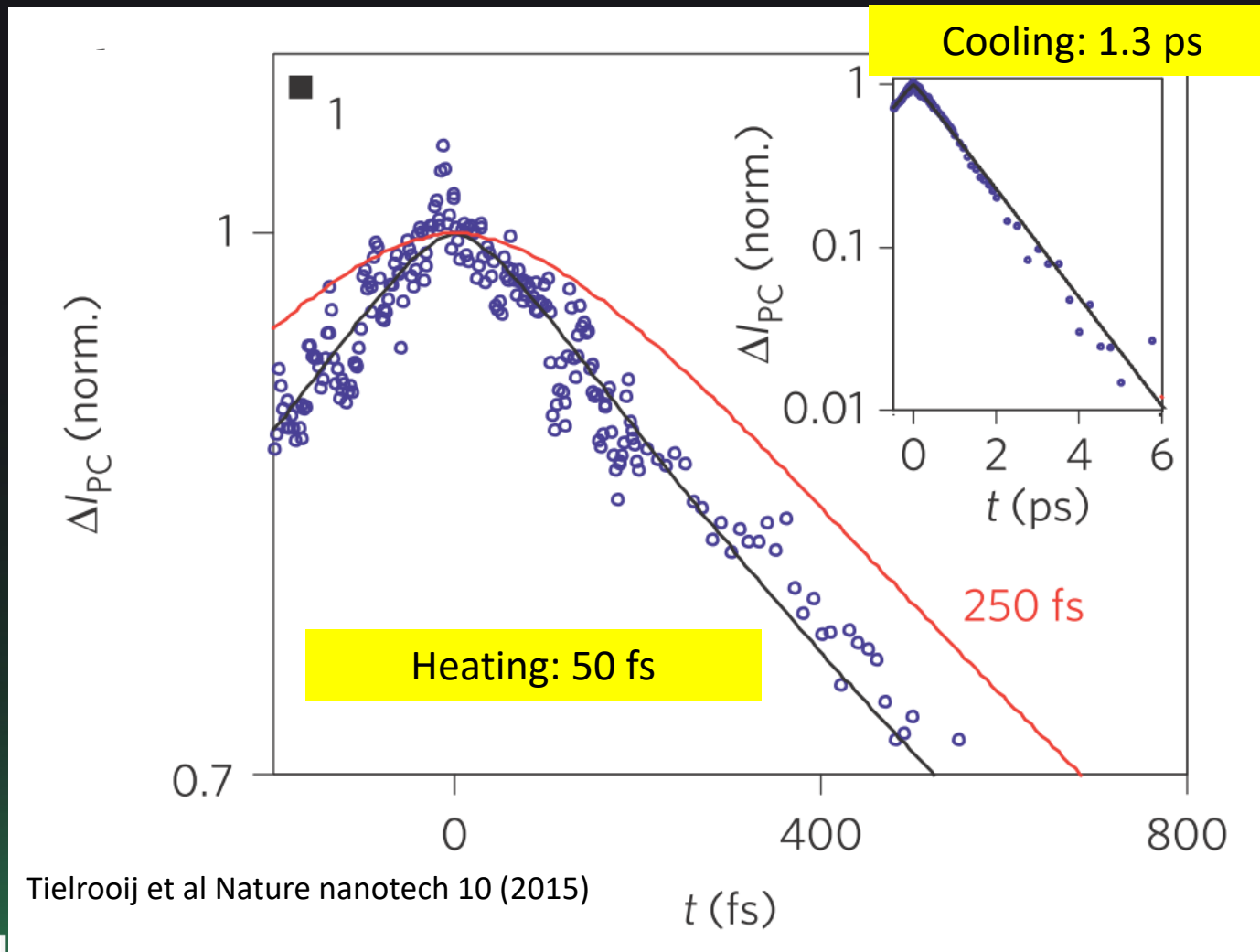
- $\lambda = 1550 \text{ nm} \rightarrow E_{\text{phot}} = 0.8 \text{ eV}$
- Kramers-Kronig relates the absorption to the refractive index  
→ refractive index is a function of the electro chemical potential

# Absorption and phase modulator



- Refractive index and absorption depend on the chemical potential
- high mobility gives low absorption for  $\mu < -0.4$  eV preferred for phase modulators.

# Ultrafast carrier dynamics in graphene



# Graphene photodetector

Type	Responsivity (A/W)	Bandwidth (GHz)	Data rate Gbps	Wavelength nm
Graphene	DC 0.2 [1] DC 0.55	>130 [1]	56	1480 to 1620 and 1980
Graphene/plasmonic [2]	0.5	>110	100	
Graphene [3]	0.36	>110	40	
Ge on Si [4]	0.8 – 0.9	120	56	
Si Ring [5]	>0.23	45	112	1310 (o-band)

- 1) Schall et al. OFC (2018)
- 2) Ma et al. ACS Photonics 6, 154 (2019)
- 3) Ding et al. arXiv:1808.04815v3 (2018)
- 4) Vivien et al. Optics Express 20, 1096 (2012)
- 5) Sakib et al. OFC Th4A.2 (2020)

# Graphene absorption modulator

Type	Modulation (dB)	Attenuation (dB)	Modulation/ Attenuation	Length (μm)	Bandwidth (GHz)	Data rate Gb/s
Graphene [1]	16	3	5	300	0.7 (DC device)	-
BEOL currently being developed	3-5	1-2	2-5	120-200	5-50*	5-56*
Graphene [2]	1.3	20	0.07	120	29	50
Graphene Simulation	16	<1	>15	<15	>50	-
Ge on Si [3]	4.6	4.1	1.1	40	>50	28

- 1) M. Mohsin et al. Optics Express 22, 15292 (2014)
- 2) Giambra et al., Optics Express 27, 20146 (2019)
- 3) S. Gupta et al. OFC (2015)

\*) bandwidth depends on the device design. Theoretical bandwidth based on technology parameters is 400 – 500 GHz  
 Datarate targets: 4 Gbps, 25 Gbps, 56 Gbps 112 Gbps; all NRZ.